



UPDATE CHANGE NOTIFICATION # 20473

Generic Copy

Issue Date: 01-Aug-2014

TITLE: To correct the top mark code stated in FPCN20473

PROPOSED FIRST SHIP DATE: 01-Aug-2014 or earlier with customer approval

AFFECTED CHANGE CATEGORY(S): ON Semiconductor Assembly Site

SAMPLES: Contact your local ON Semiconductor Sales Office or Mike Begonia
<mike.begonia@onsemi.com>

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:
Contact your local ON Semiconductor Sales Office or Mike Begonia
<mike.begonia@onsemi.com>

NOTIFICATION TYPE:

ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact <quality@onsemi.com>.

DESCRIPTION AND PURPOSE:

FPCN20473 indicates marking change as below:

CHANGED PART IDENTIFICATION:

Marking of the month date codes:

Seremban Malaysia assembled devices: M

ASE Shanghai assembled devices: ☒

TO:

The location of the assembly sites can be identified by the marking of the date code:
Seremban Facility = R plus date code
ASE Shanghai = AS plus date code

List of affected General Parts:

NIS5132MN1TXG
NIS5132MN2TXG
NIS5132MN3TXG
NIS5135MN1TXG
NIS5135MN2TXG
NIS5232MN1TXG